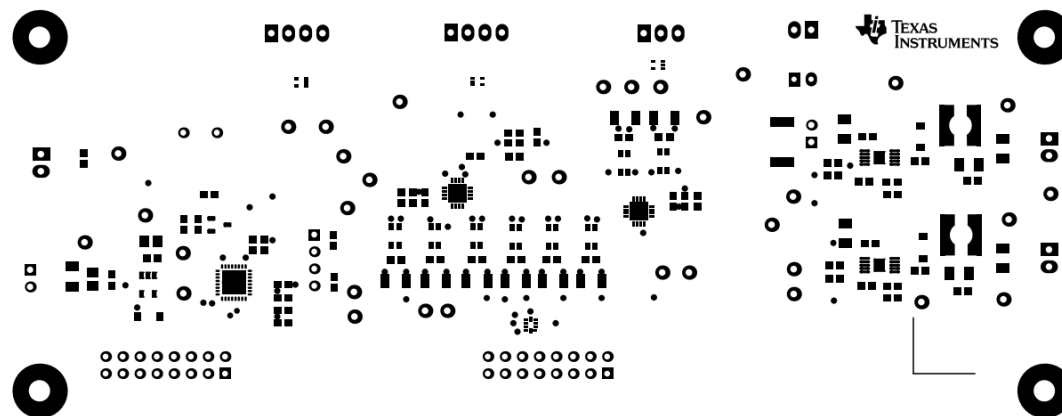
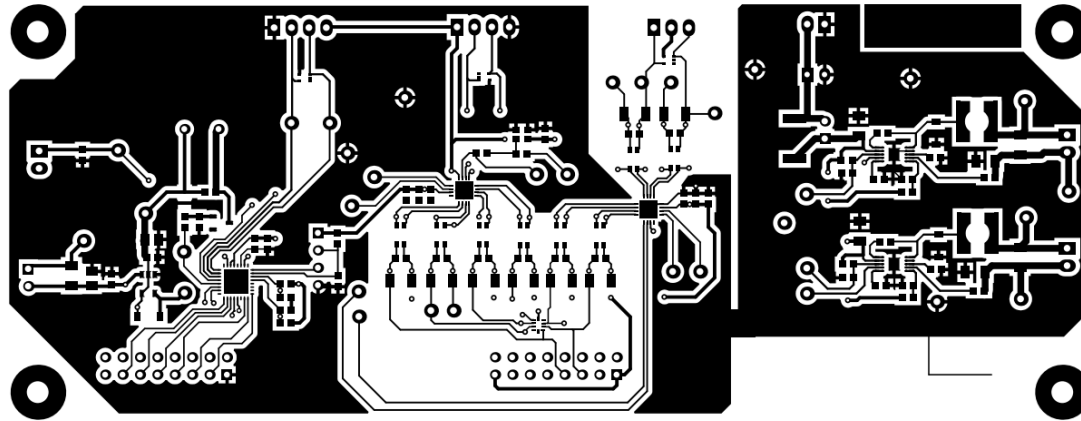


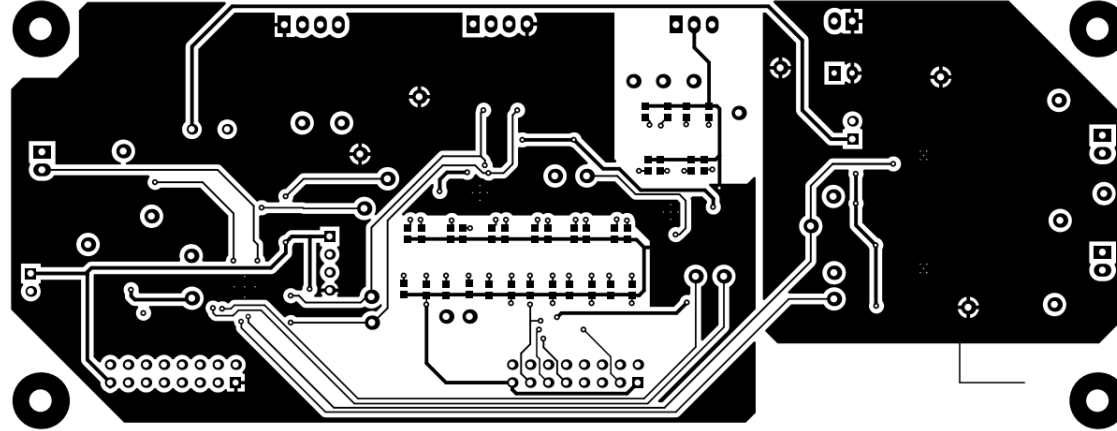
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PLOT NAME = Top Overlay	GENERATED : 9/30/2015 4:25:13 PM	TEXAS INSTRUMENTS	



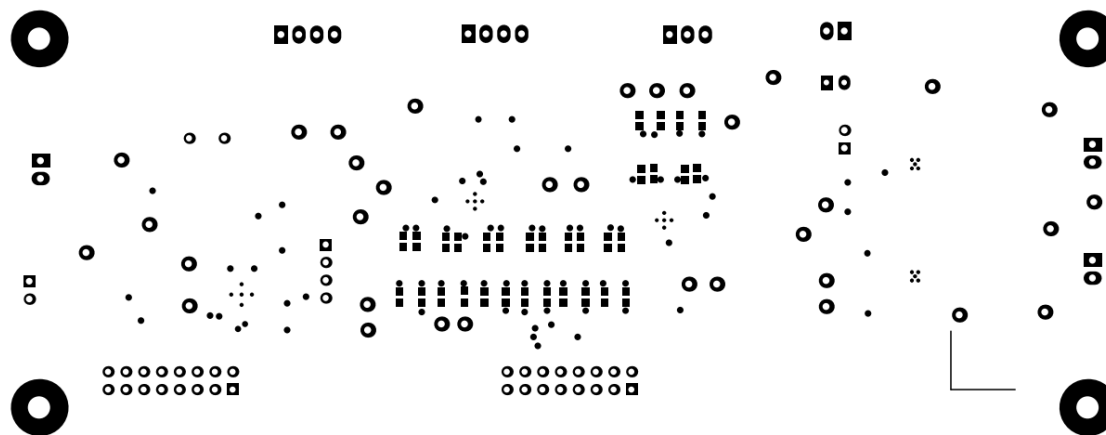
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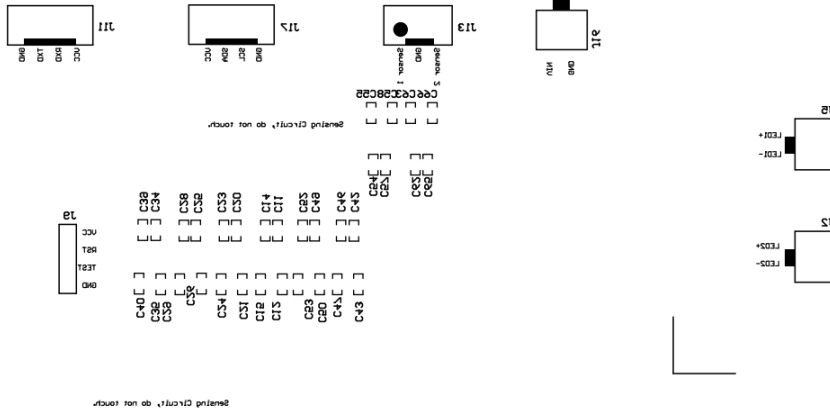
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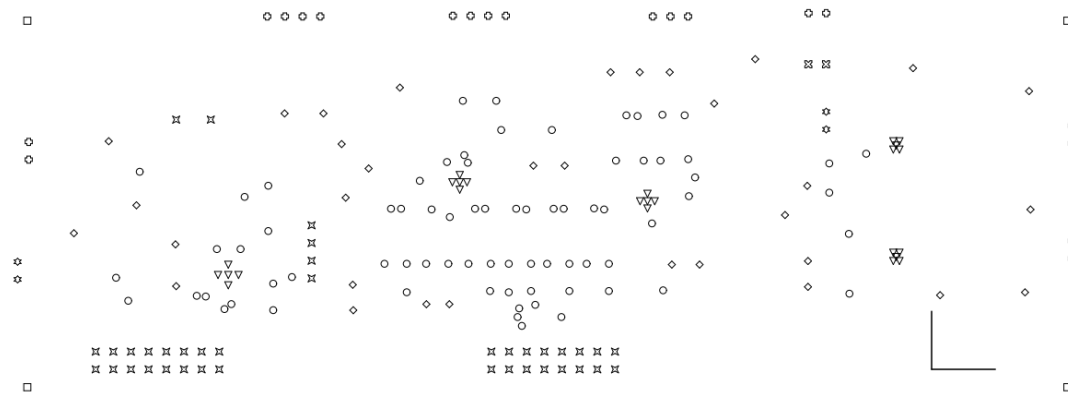
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PLOT NAME = Bottom Layer	GENERATED : 9/30/2015 4:25:13 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00474	REV: E2	SVN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder	GENERATED : 9/30/2015 4:25:13 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00474	REV: E2	SVN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 9/30/2015 4:25:13 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00474	REV: E2	SVN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 9/30/2015 4:25:13 PM	TEXAS INSTRUMENTS	

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